MP23AB02B



MEMS audio sensor high-performance analog bottom-port microphone

Datasheet - production data



Features

- Single supply voltage operation
- Low power consumption
- Omnidirectional sensitivity
- High signal-to-noise ratio
- High bandwidth
- Package compliant with reflow soldering

Description

The MP23AB02B is a compact, low-power microphone built with a low-profile sensing element.

The sensing element, capable of detecting acoustic waves, is manufactured using a specialized silicon micromachining process to produce audio sensors.

The MP23AB02B has an acoustic overload point of 125 dBSPL with a 64 dB signal-to-noise ratio.

The MP23AB02B is available in a package compliant with reflow soldering and is guaranteed to operate over an extended temperature range from -40 $^{\circ}$ C to +85 $^{\circ}$ C.

Table 1. Device summary

Order code	Temperature range (°C)	Package	Packing
MP23AB02B	-40 to +85	(3.35 x 2.5 x 0.98) mm	Tray
MP23AB02BTR	-40 to +85	(3.35 x 2.5 x 0.98) mm	Tape and reel

This is information on a product in full production.

1 Pin description

Figure 1. Pin connections

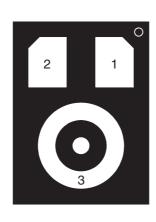


Table 2. Pin description

Pin n°	Pin name	Function
1	Out	Analog output
2	Vdd	Power supply
3	GND	Ground



2 Acoustic and electrical specifications

2.1 Acoustic and electrical characteristics

The values listed in the table below are specified for Vdd = 1.8 V, T_{amb} = 25 °C unless otherwise specified.

Symbol	Parameter	Test condition	Min.	Typ. ⁽¹⁾	Max.	Unit
Vdd	Supply voltage		1.6	1.8	3.6	V
ldd	Current consumption	mean value = 2 V		150	220	μA
So	Sensitivity	1 kHz (0 dB = 1 V/Pa)	-41	-38	-35	dBV/PA
SNR	Signal-to-noise ratio	A-weighted, 1 kHz (0 dB = 1 V/Pa)		64		dBA
Тор	Operating temperature range		-40		+85	°C

Table 3. Acoustic and electrical characteristics

1. Typical specifications are not guaranteed

Table 4. Distortion specifications at 1 kHz

Parameter	Test condition	Value
Distortion	94	< 0.5%
Distortion	120	< 2%
Distortion	124	= 10%

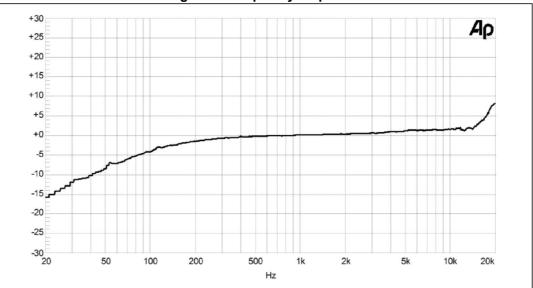


Figure 2. Frequency response



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Absolute maximum ratings 3

Stresses above those listed as "Absolute maximum ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device under these conditions is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

Symbol	Ratings	Maximum value	Unit
Vdd	Supply voltage	-0.5 to 4	V
T _{STG}	Storage temperature range	-40 to +125	°C

Table 5. Absolute	e maximum ratings
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This device is sensitive to mechanical shock, improper handling can cause permanent damage to the part.



This device is sensitive to electrostatic discharge (ESD), improper handling can cause permanent damage to the part.



4 Application recommendations

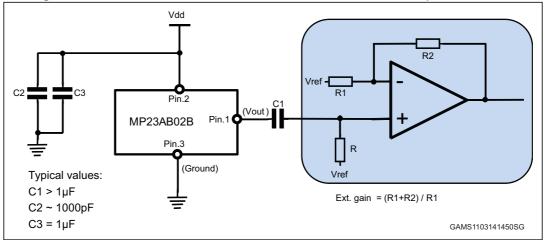


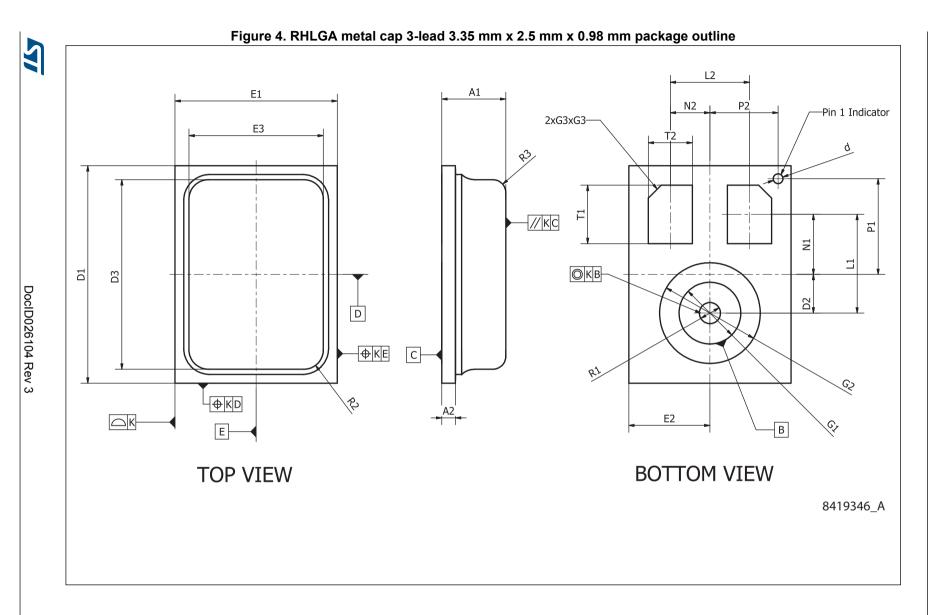
Figure 3. MP23AB02B electrical connections and external component values



5 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.



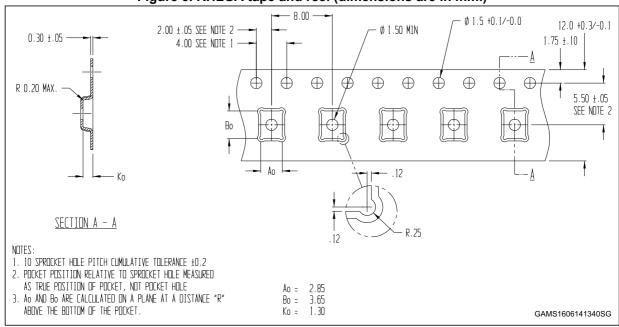


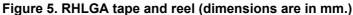
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Reference	Dimensions (mm)		
	Min.	Тур.	Max.
A1	0.880	0.980	1.080
A2	0.200	0.250	0.300
D1	3.250	3.350	3.450
D2	0.495	0.595	0.695
D3	2.770	2.920	3.070
R1	0.275	0.325	0.375
R2		0.28	
R3		0.25	
E1	2.400	2.500	2.600
E2	1.150	1.250	1.350
E3	1.920	2.070	2.220
L1	1.480	1.520	1.560
L2	1.180	1.220	1.260
N1	0.885	0.925	0.965
N2	0.570	0.610	0.650
T1	0.860	0.900	0.940
T2	0.640	0.680	0.720
G1	0.900	0.950	1.000
G2	1.400	1.550	1.600
G3	0.100	0.150	0.200
P1	1.425	1.475	1.525
P2	1.000	1.050	1.100
d		0.150	
К		0.050	

Table 6. RHLGA metal cap 3-lead (3.35 x 2.5 x 0.98 mm9 package dimensions









6 Soldering information

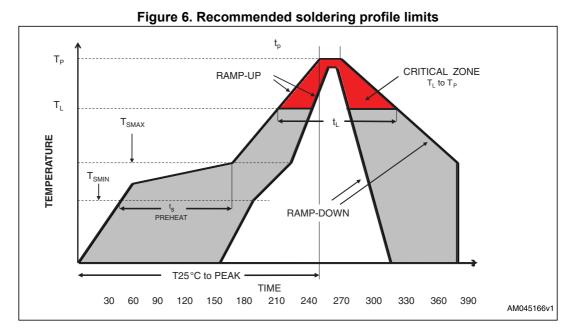


Table 7. Recommended soldering profile limits

Description	Parameter	Pb free
Average ramp rate	T _L to T _P	3 °C/sec max
Preheat		
Minimum temperature	T _{SMIN}	150 °C
Maximum temperature	T _{SMAX}	200 °C
Time (T _{SMIN} to T _{SMAX})	t _S	60 sec to 120 sec
Ramp-up rate	T_{SMAX} to T_{L}	
Time maintained above liquidus temperature	tL	60 sec to 150 sec
Liquidus temperature	TL	217 °C
Peak temperature	Τ _Ρ	260 °C max
Time within 5 °C of actual peak temperature		20 sec to 40 sec
Ramp-down rate		6 °C/sec max
Time 25 °C (t = 25 °C) to peak temperature		8 minutes max



7 Revision history

Date	Revision	Changes
21-Mar-2014	1	Initial release.
16-Jun-2014	2	Updated <i>Figure 5 on page</i> 9.
22-Sep-2014	3	Updated acoustic overload point in Description.



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